# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **General Description**

The MAX15095 family of devices is an integrated solution for hot-swap applications requiring the safe insertion and removal of circuit line cards from a live backplane. They can also be used as electronics circuit breakers for hard drives, solid-state drives, and fans. The devices integrate a hot-swap controller (10.6m $\Omega$  typ) power MOSFET, and an electronic circuit-breaker protection in a single package.

The devices are designed for protection of 2.7V to 18V supply voltages. These devices implement a foldback current limit during startup to control inrush current, lowering di/dt and keeping the MOSFET operating under safe operating area (SOA) conditions. After the startup cycle is complete, on-chip comparators provide VariableSpeed/BiLevel<sup>TM</sup> protection against short-circuit and overcurrent faults, and immunity against system noise and load transients. The load is disconnected in the event of a fault condition. The devices are factory calibrated to deliver accurate overcurrent protection with  $\pm 10\%$  accuracy. During a fault condition, PG goes low and the devices can latch off (MAX15095) or automatic retry (MAX15095A); the output can also be discharged after a fault event (MAX15095D).

The devices feature an IN-to-OUT short-circuit detection before startup. The devices provide a power-MOSFET GATE pin to program the slew rate during startup by adding an external capacitor. The devices have an undervoltage/overvoltage input pin (UVOV) that can detect an undervoltage/overvoltage fault and disconnect the IN from the OUT. Additional features include internal overtemperature protection and a power-good output (PG).

The devices are available in a 12-pin, 2.5mm x 2.5mm FC2QFN package and are rated over a  $-40^{\circ}$ C to  $+105^{\circ}$ C extended temperature range.

### **Benefits and Features**

- Integration Reduces Solution Size for Blade Servers and Other Space-Constrained Designs
  - Integrated 10.6mΩ (typ) Internal Power MOSFET
  - Programmable Overvoltage Protection and Undervoltage-Lockout Threshold
  - Drive-Present Signal Input (PRSNT pin)
  - Thermal Protection
- Flexibility Enables Use in Many Unique Designs
  - 2.7V to 18V Operating Voltage Range
  - Programmable Inrush-Current Control under SOA
     Operation
  - Adjustable Circuit-Breaker Current/Current-Limit
    Threshold
  - Programmable Slew-Rate Control
  - Variable-Speed Circuit-Breaker Response
  - Latchoff (MAX15095) or Automatic Retry (MAX15095A) Options
- Safety Features Ensure Accurate, Robust Protection
  - 6.6A (max) Load-Current Capability
  - ±10% Circuit-Breaker Threshold Accuracy
  - IN-to-OUT Short-Circuit Detection
  - Open-Drain PG Output
  - Output Discharge after a Fault Event (MAX15095D Only)
  - Programmable Additional Delay (2µs max) to Fast-Comparator Response Time
  - Enable Input (EN)

### **Applications**

- Blade Servers
- Server I/O Cards
- RAID Systems
- Disk Drive Power
- Storage Applications
- Industrial Applications

Ordering Information appears at end of data sheet.

VariableSpeed/BiLevel is a trademark of Maxim Integrated Products, Inc.



# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **Absolute Maximum Ratings**

V <sub>CC</sub> to GND	0.3V to +20V
IN to GND	0.3V to +20V
PG, PRSNT to GND	0.3V to +20V
OUT to GND	0.3V to (V <sub>IN</sub> + 0.3V)
GATE to OUT	0.3V to +6V
EN, UVOV to GND	0.3V to +6V
TIMER, CB to GND	0.3V to (V <sub>REG</sub> + 0.3V)
REG to GND	0.3V to min (+6V, (V <sub>CC</sub> + 0.3V))

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
derate 13.8mW/°C above 70°C	1.105W
Operating Temperature Range	-40°C to +105°C
Junction Temperature	150°C
Storage Temperature Range	-60°C to +150°C
Soldering Temperature (reflow)	260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Information**

PACKAGE TYPE: 12-PIN FC2QFN				
Package Code	F122A2F-1			
Outline Number	21-100198			
Land Pattern Number	90-100073			
THERMAL RESISTANCE, FOUR-LAYER BOARD				
Junction to Ambient (θJ <sub>A</sub> )	72.4°C/W			

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

### **Electrical Characteristics**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}C \text{ to } +105^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}C.$ ) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
POWER SUPPLIES	POWER SUPPLIES							
V <sub>CC</sub> Operating Range	V <sub>CC</sub>		2.7		18	V		
IN Operating Range	V <sub>IN</sub>		2.7		18	V		
V <sub>CC</sub> Supply Current		Enable		0.58	0.9	m ^		
	Icc	Disable		0.590		mA		
IN Sumply Current	I <sub>IN</sub>	$R_{CB} = 41.67 k\Omega$ , no load		3.3	3.9			
IN Supply Current		$R_{CB} = 10K\Omega$ , no load		1.3	1.8	mA		
V <sub>CC</sub> Default Undervoltage Lockout	V <sub>UVLO</sub>	V <sub>CC</sub> rising	2.35	2.5	2.65	V		
V <sub>CC</sub> Default Undervoltage-Lockout Hysteresis	V <sub>UVLO_HYS</sub>			0.1		V		
REG Regulator Voltage	V <sub>REG</sub>	No load, V <sub>CC</sub> > 4V	3	3.3	3.6	V		

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **Electrical Characteristics (continued)**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}.)$  (Note 1)

PARAMETER	SYMBOL	co	NDITIONS	MIN	TYP	MAX	UNITS	
UV Turn-On Threshold	V <sub>UV_TH</sub>	V <sub>UVOV</sub> rising		0.536	0.55	0.564	V	
UV Turn-On Threshold Hysteresis	V <sub>UV_HYS</sub>	V <sub>UVOV</sub> falling			50		mV	
OV Turn-On Threshold	Vov th	V <sub>UVOV</sub> rising		1.199	1.23	1.261	V	
OV Turn-On Threshold Hysteresis	V <sub>OV_HYS</sub>	V <sub>UVOV</sub> falling			50		mV	
OVUV Input Leakage Current	ILEAK	V <sub>UVOV</sub> = V <sub>EN</sub> =	= 0V to 5.5V	-1		+1	μA	
CURRENT LIMIT		,						
		N = 40V	R <sub>CB</sub> = 41.2kΩ	6	6.6	7.2		
		V <sub>IN</sub> = 12V	R <sub>CB</sub> = 10.5kΩ	1.2	1.43	1.66		
Circuit-Breaker Accuracy (Note 2)	ІСВ_ТН	V <sub>IN</sub> = 3.3V, T <sub>A</sub> = 85°C (Note 3, 4)	R <sub>CB</sub> = 46.4kΩ	7.0	7.7	8.4	A	
Circuit-Breaker Accuracy Deviation (Note 4)			to 21.5k $\Omega$ , compared to t-limit value, V <sub>IN</sub> = V <sub>CC</sub>	-16		+16	%	
		R <sub>CB</sub> = 21.5kΩ t nominal current	to 41.2kΩ, compared to t-limit value	-10		+10		
Slow-Comparator Response Time		0.6% overcurre	nt		2.7		ms	
(Note 5)	tscD	30% overcurrer	nt		200		μs	
CB Source Current	ITHCB_NORM	In power-on mode			12		μA	
Maximum Current Limit During Startup	ILIM	(see Figure 2)			0.5 х І <sub>СВ ТН</sub>		A	
Fast-Comparator Threshold	I <sub>FC_TH</sub>				1.5 х І <sub>СВ ТН</sub>		A	
Fast-Comparator Response Time	t <sub>FCD</sub>				200		ns	
Additional Delay Time by TIMER	tAFCD	R <sub>TIMER</sub> = open	1		2		μs	
Minimum CB Voltage Reference During Foldback (Note 6)	V <sub>THCB_MIN</sub>	V <sub>IN</sub> - V <sub>OUT</sub> > 1	0V, R <sub>CB</sub> = 41.2kΩ		60		mV	
Maximum CB Voltage Reference During Foldback (Note 6)	V <sub>THCB_MAX</sub>	V <sub>IN</sub> - V <sub>OUT</sub> < 2	V, R <sub>CB</sub> = 41.2kΩ		250		mV	
TIMING		·						
Startup Maximum Time Duration	t <sub>SU</sub>			43	52	61	ms	
Autoretry Delay Time	t <sub>RESTART</sub>	MAX15095A and MAX15095D only			3.4		s	
Output Short Detection at Startup	t <sub>SHORT</sub>			10.4	13.2	15.6	ms	
MOSFET								
		T <sub>A</sub> = +25°C, I <sub>O</sub>	UT = 0.5A		10.6	14.3		
Total On Pasistance		T <sub>A</sub> = -40°C to +	-105°C, I <sub>OUT</sub> = 0.5A			18		
Total On-Resistance	R <sub>ON</sub>	$T_A = +70^{\circ}C, V_{IN} = 3.3V, I_{OUT} = 4A$ (Note 4)				18	- mΩ	

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **Electrical Characteristics (continued)**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}C \text{ to } +105^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}C.$ ) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OUTPUTS	l	L				1
PG Output Low Voltage	V <sub>OL</sub>	Low-impedance state, I <sub>PG</sub> = +5mA			0.4	V
PG Output High-Leakage Current	Іон	High-impedance state, V <sub>PG</sub> = 16V			1	μA
DISCHARGE						
		V <sub>OUT</sub> < 7.1V (MAX15095D only)	50	100	160	
Discharge Current After PG Deasserted	IDISCHARGE	VOUT ≥ 7.1V to 18V         710mW/           (MAX15095D only)         VOUT		710mW/ V <sub>OUT</sub>		mA
PG THRESHOLD	L					1
PG Threshold	V <sub>PG</sub>	V <sub>IN</sub> = 12V		0.9 x V <sub>IN</sub>		V
PG Assertion Delay	t <sub>PG</sub>	From V <sub>OUT</sub> > V <sub>PG</sub> and V <sub>GATE</sub> - V <sub>OUT</sub> > 3V	12	16	20	ms
OUT-to-IN Short-Circuit Detection Threshold	VIOSHT	Measured at V <sub>OUT</sub>		0.9 x V <sub>IN</sub>		v
OUT Preload Threshold	V <sub>PL</sub>	Measured at V <sub>OUT</sub>		0.5 x V <sub>IN</sub>		V
INPUTS						
Input Logic Threshold EN	V <sub>EN_TH</sub>	Rising	0.95	1	1.05	V
Threshold Hysteresis EN	V <sub>EN_TH_HYS</sub>	Falling		50		mV
Input Logic Threshold PRSNT	V <sub>PRSNT_TH</sub>	Falling	0.92	0.97	1.02	V
Threshold Hysteresis PRSNT	VPRSNT_TH_HYS	Rising		50		mV
EN Bias Current	I <sub>EN_BIAS</sub>	V <sub>EN</sub> = 0 or 5.5V			1	μA
PRSNT Input Bias Current	IPRSNT_BIAS	V <sub>PRSNT</sub> = 0 or 18V			1	μA
EN Deglitch Time	t <sub>EN_DEG</sub>			100		μs
PRSNT High-to-Low Deglitch Time	tPRSNT_DEG			400		μs
THERMAL SHUTDOWN						
Thermal Shutdown	TSD	T <sub>J</sub> rising		145		°C
Thermal Shutdown Hysteresis		T <sub>J</sub> falling		125		°C

**Note 1:** All devices are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over temperature are guaranteed by design.

**Note 2:** 41.2kΩ is the maximum allowed external resistance value to be connected at the CB pin to GND for safe operation over the full 2.7V to 18V V<sub>IN</sub> range. The parameter specified at  $R_{CB}$  = 41.2kΩ is guaranteed by bench characterization and correlation, with respect to the tested parameter at  $R_{CB}$  = 10.5kΩ. The formula that describes the relationship between  $R_{CB}$  and the circuit-breaker current threshold is:  $I_{CB}$  = ( $R_{CB}$ /5920) - ( $V_{IN}$ /33).

**Note 3:** The CB resistance can be increased to  $46.4k\Omega$  if V<sub>IN</sub> is between 2.7V and 3.6V, with operating current of 6.6A for no longer than 500ms. Do not exceed 6A continuous current.

Note 4: Guaranteed by design and not production tested.

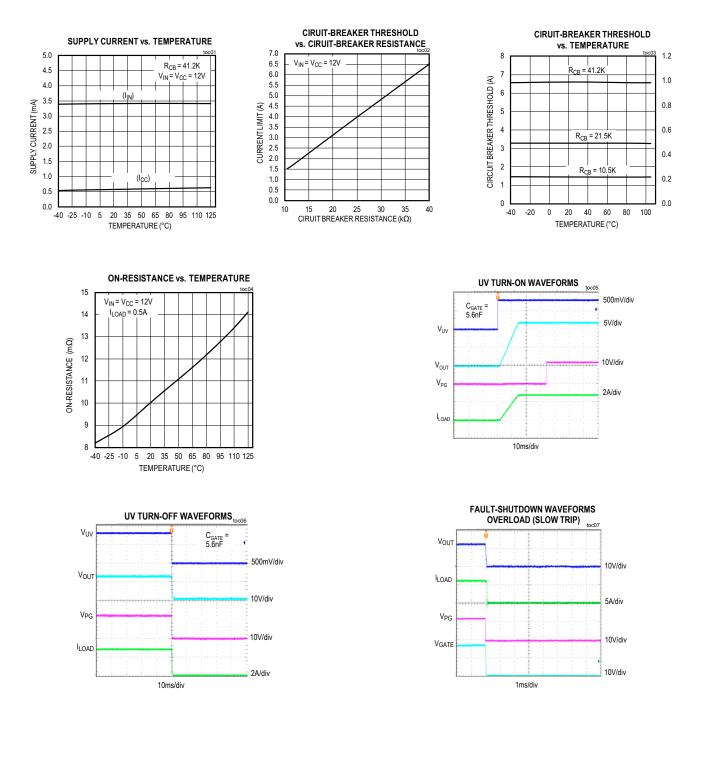
**Note 5:** The current-limit slow-comparator response time is weighed against the amount of overcurrent so the higher the overcurrent condition, the faster the response time.

Note 6: Foldback is active during the startup phase so the internal power MOSFET operates within SOA.

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

### **Typical Operating Characteristics**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{IN} = 12V$ ,  $R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .)

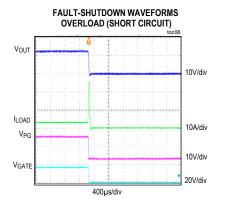


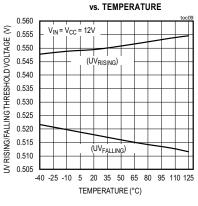
# 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

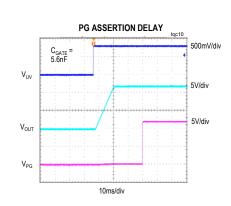
### **Typical Operating Characteristics (continued)**

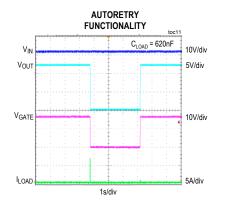
 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .)

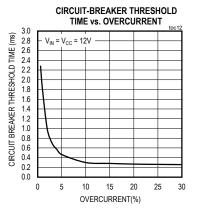
UV RISING/FALLING THRESHOLD

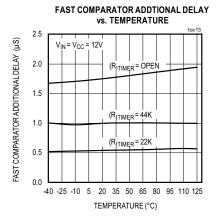




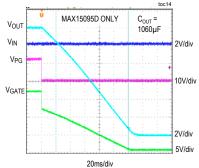






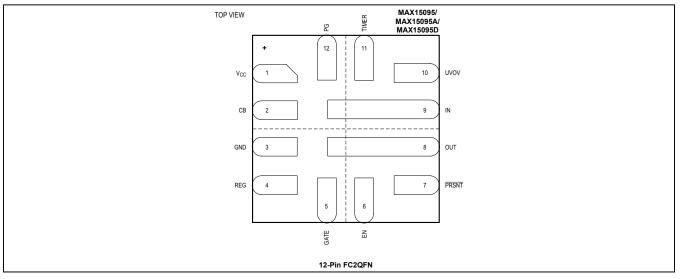






# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

## **Pin Configuration**

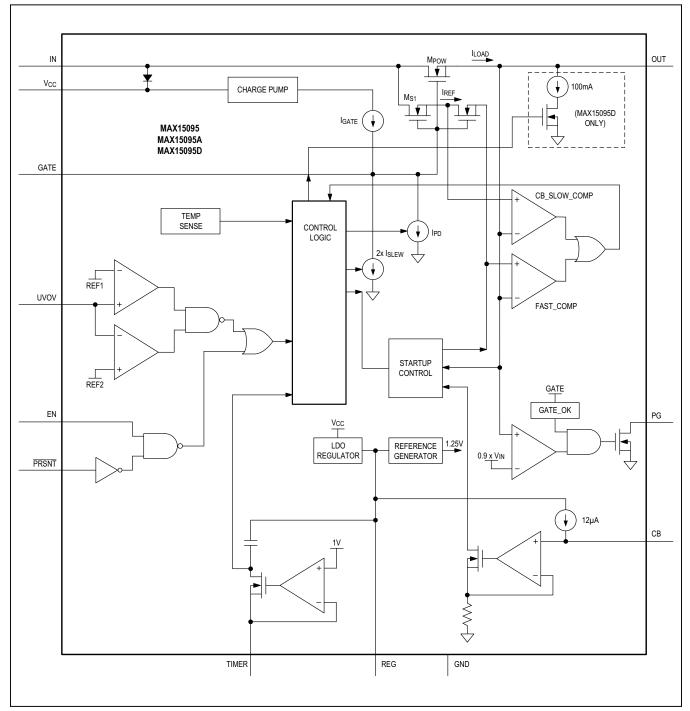


### **Pin Description**

PIN	NAME	FUNCTION
1	VCC	Power-Supply Input. Connect V <sub>CC</sub> to a voltage between 2.7V and 18V. Connect a Schottky diode (or 10 $\Omega$ resistor) from IN to V <sub>CC</sub> , and a 1µF bypass capacitor to GND to guarantee full operation in the event V <sub>IN</sub> collapses during a strong short from OUT to GND.
2	СВ	Current-Limit Threshold Set. Connect a resistor from CB to GND to set the circuit-breaker threshold. Having the CB pin connected to GND sets the circuit- breaker threshold at 0A.
3	GND	Ground
4	REG	Internal Regulator Output. Bypass to ground with a 1µF capacitor. Do not power external circuitry using the REG output.
5	GATE	Gate of Internal MOSFET. During startup, a $5.9\mu$ A (typ) current is sourced to enhance the internal MOSFET with a 10V/ms slew rate. Connect an external capacitance from GATE to GND to reduce the output slew rate during startup.
6	EN	Active-High Enable Comparator Input. Pulling EN high enables the output if PRSNT is held low.
7	PRSNT	Active-Low Present-Detect Logic Input. Pulling PRSNT to GND enables the output if EN is high.
8	OUT	Load Output. Source of the internal power MOSFET.
9	IN	Supply Voltage Input. IN is connected to the drain of the internal $10.6m\Omega$ (typ) MOSFET. Bypass IN with a transient voltage-suppressor diode to GND for clamping inductive kick transients in the case of fast output short circuit to GND.
10	UVOV	Undervoltage and Overvoltage Threshold Pin. UVOV sets the under/overvoltage threshold.
11	TIMER	Timing Input. Connect a resistor from TIMER to GND to program the maximum time the part is allowed to remain in current limit. See the <i>TIMER</i> section. If TIMER is not connected, the parasitic capacitance between TIMER and GND must be less than 10pF.
12	PG	Power-Good Output. PG is an open-drain output. Connect to an external pullup resistor to make it an active-high output. PG pulls low until the internal power MOSFET is fully enhanced.

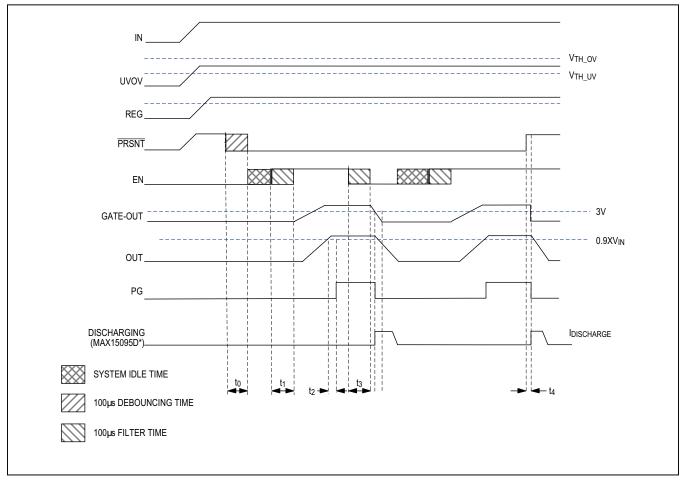
# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

## **Block Diagram**



# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

## **Timing Diagram**



### Table 1. Timing

TIMING PARAMETER	MIN	ТҮР	MAX	UNITS
t <sub>0</sub>	—	400	—	μs
t <sub>1</sub>	—	100	—	μs
t <sub>2</sub>	12	16	20	ms
t <sub>3</sub>	—	100	—	μs
t <sub>4</sub>	—	0.5	—	μs

### **Detailed Description**

#### Enable Logic and Undervoltage/ Overvoltage-Lockout Threshold

The supply output can become active only after all the following events have occurred:

- IN is within the UVOV window
- V<sub>CC</sub> is above its UVLO threshold
- EN meets its enable threshold for more than  $100 \mu s$
- PRSNT is low for more than 400µs

The MAX15095 family of devices enables the outputs as shown in <u>Table 1</u>. The devices are ready to drive the output when the V<sub>CC</sub> supply rises above the V<sub>UVLO</sub> threshold. The devices turn on the output when V<sub>CC</sub> > V<sub>UVLO</sub>, V<sub>UVOV</sub> is higher than 0.55V (V<sub>UV\_TH</sub>) and less than 1.23V (V<sub>OV\_TH</sub>). The devices turn off the output when V<sub>UVOV</sub> falls below (0.55V - V<sub>UV\_HYS</sub>) or V<sub>UVOV</sub> rises above 1.23V. An external resistive divider (as shown in Figure 1) from IN to UVOV and ground provide the

#### Table 2. Output-Enable Truth Table

2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

flexibility to select the undervoltage/overvoltage-lockout threshold to the desired value. Set the UVOV threshold using the following equations:

#### Startup

Once the devices' output is enabled, the device provides controlled application of power to the load. The voltage at OUT begins to rise at approximately 10V/ms default until the programmed circuit-breaker current level is reached, while the devices actively limit the inrush current at the circuit-breaker setting. An external capacitance connected to the GATE pin allows the user to program the slew rate to a value lower than the default. The inrush current can be programmed by appropriate selection of  $R_{CB}$ . During startup, a foldback current limit is active to protect the internal MOSFET to operate within a safe operating area. (Figure 2).

POWER SUPPLY	PRECISION AN		
V <sub>CC</sub> UVLO	UVP	OVP	OUT
V <sub>CC</sub> > V <sub>UVLO</sub>	V <sub>UVOV</sub> > V <sub>UV_TH</sub>	V <sub>UVOV</sub> < V <sub>OV_TH</sub>	On
V <sub>CC</sub> < V <sub>UVLO</sub>	X	Х	Off
Х	V <sub>UVOV</sub> < (V <sub>UV_TH</sub> - V <sub>UV_HYS</sub> )	Х	Off
Х	X	V <sub>UVOV</sub> > V <sub>OV_TH</sub>	Off

X = Don't care.

 $V_{UV_{TH}} = 0.55V (typ).$  $V_{OV_{TH}} = 1.23V (typ).$ 

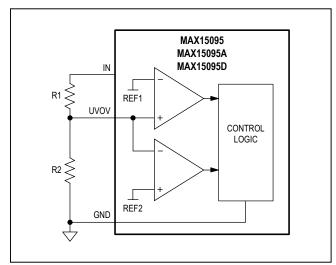


Figure 1. Undervoltage/Overvoltage Threshold Setting

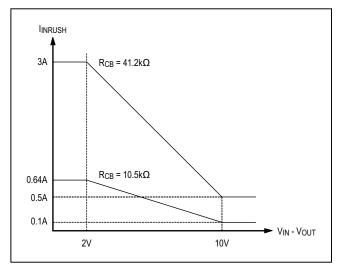


Figure 2. Startup Inrush Current Foldback Characteristics

An internal 52ms (typ) timer starts counting when the device enters a startup phase. The devices complete the startup phase and enter normal operation mode if the voltage at OUT rises above the preload threshold ( $0.9 \times V_{IN}$ ) and ( $V_{GATE} - V_{OUT}$ ) > 3V. An open-drain power-good output (PG) goes high impedance 16ms after the startup successfully completes. The thermal-protection circuit is always active and the internal MOSFET is immediately turned off so a thermal-shutdown threshold condition can be reached.

If the startup is not successful because the output is shorted or the load is too high (OUT voltage < 1V), the devices turn off the hot-swap switch after the output short detection at startup  $t_{SHORT}$  (13.2ms) elapses.

#### VariableSpeed/BiLevel-Fault Protection

VariableSpeed/BiLevel-fault protection incorporates comparators with different thresholds and response times to monitor the load current (Figure 3). Protection is provided in normal operation (after the startup period has expired) by discharging the MOSFET gate in response to a fault condition. During a fault condition, the MAX15095A enters an autoretry mode while the MAX15095 latches off (see the *Autoretry and Latchoff-Fault Management* section).

#### Enable Input (EN)

The devices allow for enabling the MOSFET in an activehigh configuration. When all other enabling conditions are verified and the EN pin is at a logic-high level, the MOSFET is enabled. Similarly, when the EN pin is at a logic-low level, the MOSFET is disabled.

#### **Charge Pump**

An integrated charge pump provides the gate-drive voltage for the internal power MOSFET. The charge pump generates the proper gate-drive voltage above  $V_{IN}$  to fully enhance the internal power MOSFET and guarantee low  $R_{ON}$  operation during normal-state condition.

During startup, the internal charge pump drives the GATE of the MOSFET with a fixed 5.9 $\mu$ A current to enhance the internal MOSFET with 10V/ms (typ) slew rate. To reduce the output slew rate during startup below 10V/ms, connect an external capacitor (C<sub>GATE</sub>) from GATE to GND. The value of C<sub>GATE</sub> is determined according to the equation:

where  $I_{GATE}$  is 5.9µA (typ),  $t_{ON}$  is the desired output ramp-up time, and  $V_{OUT}$  is the final output voltage.

The slew rate of the OUT pin during startup is controlled by  $I_{GATE}/C_{GATE}$  under light-load conditions, but under heavier load, the foldback current limit and the external capacitive load will determine the actual slew rate.

$$\Delta V_{OUT}/\Delta t$$
) = (I<sub>LIM</sub> - I<sub>LOAD</sub>)/C<sub>LOAD</sub>

where  $I_{LIM}$  represents the voltage-dependent foldback current limit. See <u>Electrical Characteristics</u>.table and <u>Figure 3</u>. The load current is subtracted from  $I_{LIM}$ , because any current consumed by the load does not help charge the output capacitance.

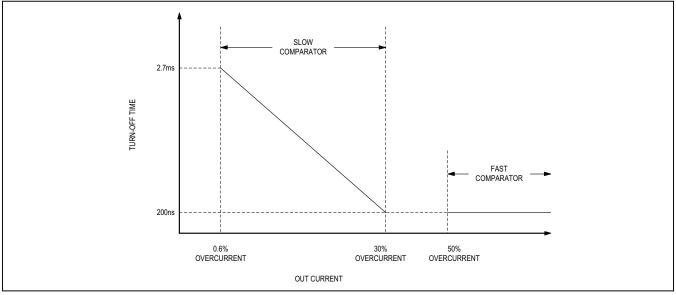


Figure 3. VariableSpeed/BiLevel Response

#### Circuit-Breaker Comparator and Current Limit

The current through the internal power MOSFET is compared to a circuit-breaker threshold. An external resistor between CB and ground sets this threshold according to the following formula:

 $I_{CB}(A) = (R_{CB} / 5920) - (V_{IN} / 33)$ 

where  $R_{CB}$  is the resistor between CB and ground.

The circuit-breaker comparator is designed so that the load current can exceed the threshold for some amount of time before tripping. The time delay varies inversely with the overdrive above the threshold. The greater the overcurrent condition, the faster the response time, allowing the devices to tolerate load transients and noise near the circuit-breaker threshold. The operating current should not be allowed to exceed 6.6A for longer than 500ms. The maximum allowed external resistor value is 46.4k $\Omega$ .

The devices also feature catastrophic short-circuit protection. During normal operation, if OUT is shorted directly to ground, a fast protection circuit forces the gate of the internal MOSFET to discharge quickly and disconnect the output from the input.

#### Autoretry and Latchoff-Fault Management

During a fault condition, the devices turn off the internal MOSFET, disconnecting the output from the input. The MAX15095A enters an autoretry mode and restarts after  $t_{RESTART}$  (3.4s typ) time delay elapses.

The MAX15095 latches off and remains off until the enable logic is cycled off and on after a certain delay. The delay prevents the latchoff device from restarting and operating with an unsafe power-dissipation duty cycle. See the *Timing Diagram* and Table 1 for delay values.

#### Latchoff Reset

The latchoff could be reset if any one of the following happens:

- V<sub>CC</sub> is below its UVLO threshold
- EN is disabled for longer than 100µs
- UV is triggered
- PRSNT goes above its threshold
- OV is triggered

#### Power-Good (PG) Delay

The devices feature an open-drain, power-good output that asserts after  $t_{PG}$  delay, indicating that OUT voltage has reached (0.9 x V<sub>IN</sub>) voltage and (V<sub>GATE</sub> - V<sub>OUT</sub>) > 3V.

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

#### REG

The devices include a linear regulator that outputs 3.3V at REG. REG provides power to the internal circuit blocks of the devices and must not be loaded externally (except a resistor >  $50k\Omega$  connected from REG to EN). REG requires a 1µF capacitor to ground for proper operation.

#### **Output Discharging**

The discharge FET is active when the output is disabled or under fault event. In this event, the hot-swap is off and the output is on the way down. The discharging is triggered after the main FET has completely turned off.

The maximum output capacitance is approximately  $1000\mu$ F. The voltage could be up to 18V. Ideally, it discharges the output capacitor in constant-power mode (710mW typ) to ensure the voltage rail is below 0.3V within 2s or less.

#### TIMER

Connect a resistor from the TIMER pin to the GND pin to program the fast-trip response time. This time is the sum of the internal fast-comparator propagation delay (less than 200ns typ) plus an additional delay set by the external resistor connected from TIMER to ground. Choosing different resistance values, it is possible to change the value of additional delay. If the TIMER pin is connected to REG, the total response time is less than 200ns (typ).

Additional delay is disabled also during the startup phase or after a short-circuit event ( $V_{OUT} < 90\% V_{IN}$ ). Be careful about additional delay settings related to a short event.

Additional delay can be calculated using the following formula:

Additional\_Delay ( $\mu$ s) = R<sub>TIMER</sub> (k $\Omega$ ) x 22.9E<sup>-03</sup>

Maximum additional delay time is set to  $2\mu s$ . Table 3 provides additional delay settings.

#### **Table 3. Additional Delay Settings**

OPTION	R <sub>TIMER</sub> (kΩ)	RESPONSE TIME (µs)
1	Open	2
2	86.6	2
3	43.2	1
4	21.5	0.5
5	11	0.25
6	0	0.050

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

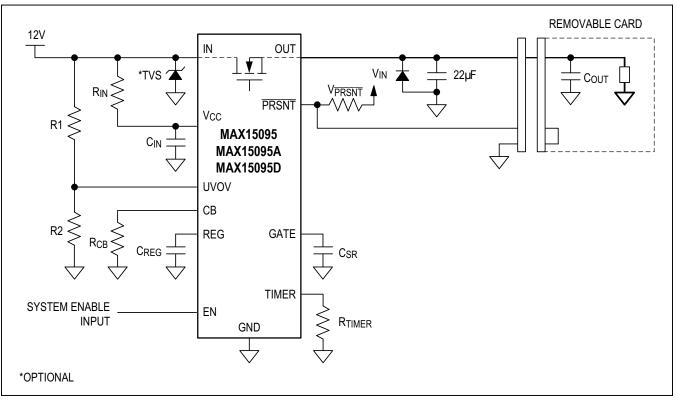
#### **Thermal Protection**

The devices enter a thermal shutdown mode in the event of overheating caused by excessive power dissipation or high ambient temperature. When the junction temperature exceeds  $T_J = 145$ °C (typ), the internal thermal protection circuitry turns off the internal power MOSFET. The devices recover from thermal shutdown mode once the junction temperature drops by 20°C (typ).

#### **IN-to-OUT Short-Circuit Protection**

At startup, after all the input conditions are satisfied (UV, OV, V<sub>UVLO</sub>), the devices immediately check for IN-to-OUT short-circuit faults. If V<sub>OUT</sub> is greater than 90% of V<sub>IN</sub>, the internal MOSFET cannot be turned on, then the MAX15095A autoretries in t<sub>RESTART</sub> (3.4s typ), while the MAX15095 latches off.

If V<sub>OUT</sub> is in the range from 50% to 90% of V<sub>IN</sub>, then the internal MOSFET still cannot be turned on after t<sub>SU</sub> time elapses. The MAX15095A autoretries in t<sub>RESTART</sub>, while the MAX15095 latches off.



### **Typical Application Circuit**

### **Ordering Information**

PART	TEMP RANGE (°C) PIN-PACKAGE FAULT MANAGE		FAULT MANAGEMENT
MAX15095GFC+	-40 to +105	12 FC2QFN	Latchoff
MAX15095AGFC+	-40 to +105	12 FC2QFN	Autoretry
MAX15095DGFC+	-40 to +105	12 FC2QFN	Autoretry

+Denotes a lead (Pb)-free/RoHS-compliant package.

### **Chip Information**

PROCESS: BICMOS

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	2/18	Initial release	—
1	3/18	Updated TOC01–04, TOC09, and TOC13	5—6
2	4/19	Updated <i>Electrical Characteristics</i> table and the <i>EC Notes</i> section. Updated <i>Pin Description</i> table and the <i>Circuit-Breaker Comparator and Current Limit</i> section under the <i>Detailed Description</i>	3, 4, 7, 12
3	4/19	Corrected the Charge Pump section text and equations.	11
4	7/19	Corrected units for V <sub>CC</sub> Supply Current (I <sub>CC</sub> )	2

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